Abstract—A process corner monitoring circuit (PCMC) is presented in this work. The circuit generates a signal, the logical value of which depends on the process corner only. The signal can be used in both digital and analog circuits for testing and compensation of process variations (PV). The presented circuit uses only metal-oxide-semiconductor (MOS) transistors, which allow increasing its detection accuracy, decrease power consumption and area. Due to its simplicity the presented circuit can be easily modified to monitor parametrical variations of only n-type and p-type MOS (NMOS and PMOS, respectively) transistors, resistors, as well as their combinations. Post-layout simulation results prove correct functionality of the proposed circuit, i.e. ability to monitor the process corner (equivalently die-to-die variations) even in the presence of within-die variations.

Keywords—Detection, monitoring, process corner, process variation.

I. INTRODUCTION

Within decades, scaling of complementary metal-oxide-semiconductor (CMOS) technologies has played a critical role, significantly improving performance of devices and circuits [1]. In modern deep submicron technologies, different factors including newer effects in MOS transistors impede the continuous scaling. PV [2], [3] are considered to be a very important to target since they adversely affect integrated circuits’ (IC) performance, particularly decreasing their yield. In addition to PV characterization [4], lots of techniques and circuits have been developed [5]-[8] to design robust circuits, detect PV, compensate their impact. Development of PV detection and compensation circuits is in its turn challenging. Modern PV monitoring circuits use several metrics to get information on PV - logic gate delays and slew rates [7], [8], transistor leakage currents [5], [6], transistor threshold voltage, dynamic current etc.

II. EXISTING TECHNIQUES

Most of modern PCMCs use a common principle of “measurement”, when a variable (metric) subject to variation is compared with a reference one. The widely used reference variables (or sources) are voltage, current [6] and frequency [5]. After comparison with a reference variable, digital or analog signals are generated, the value of which characterizes the process corner. These signals are then used as PV indicators, or for compensation [9] in different analog and digital circuits.

In [5] the subthreshold leakage current of MOS, the transistor is used for PV monitoring; a simplified block-diagram of the circuit is shown in Fig. 1. It consists of a reference current and voltage sources ($I_{ref}$ and $V_{ref}$ respectively), current mirror (transistors $M_0$ and $M_1$) and a transistor ($M_2$) operating in subthreshold region.

For the proposed leakage sensing circuit to reflect only the variation in $M_2$ and not the variation in the rest of the circuit, both $I_{ref}$ and $V_{bias}$ must be designed to be PV insensitive. $V_{SEN}$ is the drain voltage of $M_2$ that indicates the leakage level and is determined by the equilibrium of the $M_1$, $M_2$ drain currents and corresponds to the voltage at the intersection point of the load lines, as in Fig. 2. Since the current $I_{ref}$ is insensitive to PV, while $I_{M2}$ strongly depends on PV (via threshold voltage, etc.), output voltage $V_{SEN}$ changes with PV. E.g. in “fast” corner I/V characteristics of the $M_2$ “move up”, consequently, smaller output voltage is generated, and thus, depending on process corner (or PV), high or low voltage is generated. $V_{SEN}$ is then compared with $V_{REF}$, generating a digital signal ($d_0$).

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A block diagram of the slew-rate monitoring circuit, described in [7] is shown in Fig. 3. It consists of an oscillator, comparators, XOR gate, multiplexer and a charge pump. The oscillator generates a digital signal, which drives comparators A and B. They have different voltage threshold levels (80% and 20% of the supply, respectively). These levels are used to measure rise and fall times of a single pulse. Comparators’ output signals drive the XOR, which generates two subsequent pulses. The pulse width of the first (R) and second (F) pulses are equal to the rise and fall slews of the input signal respectively. By selecting these pulses (at different time points) multiplexer “MUX” generates two signals (PR and PF): one corresponding to the rise edge and another to the fall edge. The signal “PR” charges the capacitor of the charge pump (CP), while “PF” discharges it back. The output voltage of CP is proportional to the difference between rise and fall slews of the input signal. The output voltage can then be used in voltage controlled oscillator (VCO). Measuring VCO’s frequency PV can be monitored.

Most of the modern PCMCs suffer from several drawbacks, which limit their usage in various applications. One drawback is the usage of reference voltage/current sources. There are tradeoffs between reference voltage/current variation and area/current consumption, since very accurate sources use bipolar transistors and resistors, and have larger area, consume more current, while low-area sources based on only MOS transistors, have lower accuracy (larger variation). These tradeoffs affect PCMC’s performance significantly. The next factor is the presence of one or more converters, e.g. voltage-to-voltage/code converter, current-to-frequency converter (oscillator), all of which suffer from PV, i.e. usage of parameter conversion creates additional process dependency, worsening PCMC’s performance.

III. PROPOSED CIRCUIT

The proposed PCMC is shown in Fig. 4. It is a self-biased [10] circuit with positive and negative feedback loops. The first loop consists of transistors M1 and M2, while the second loop consists of transistors M3-M6. Due to specific “shape” of voltage transfer characteristics (V1 vs. Vout and V2 vs. Vout) of both loops stable operating points, and hence, output voltage (Vout) are formed.

The operation principle of the circuit is based on a “shape” of the transfer characteristics which are designed in a way that in some corners the circuit has a non-zero operating point (the plots have a non-zero crossing point), while in other corners it has zero operating point (the plots cross at zero). Thus, due to process corner change the output voltage (Vout) changes from certain voltage to 0 (or vice versa). To illustrate the operation principle of the circuit, it is necessary to first derive transfer characteristics of both loops.

Since the transistors operate in different regions (strong inversion, weak inversion), it is necessary to derive the transfer characteristics using different equations for corresponding regions. In the first loop at small (smaller than threshold voltage of transistors) input voltages (Vout), both transistors M1 and M2 operate in subthreshold region where current-voltage dependence is exponential [11]. Using the square law model [10] for current-voltage characteristics of the transistors, we obtain:

\[
V_{out} = V_{1} - V_{T} \ln \left( 1 - s_{1} e^{\frac{V_{1}}{m_{1}V_{T}}} + s_{2} e^{\frac{V_{1}}{m_{2}V_{T}}} \right)
\]  

where \(V_{T}\) is the thermal voltage, \(s_{1}=\beta_{n2}/\beta_{01}, \beta_{n}=\mu_{n}C_{ox}W_{i}/L_{i}, \mu_{n}\) is the mobility of carriers in channel, \(C_{ox}\) is oxide capacitance per unit area, \(W_{i}/L_{i}\) are channel width/length of i-th transistor. At large (larger than threshold voltage of transistors) input voltages (Vout) both transistors M1 and M2 operate in strong inversion region [10], transistor M1 is in saturation, while the M2 is in linear region. Using the square law model [10] for current-voltage characteristics of the transistors, we obtain:
where $V_{th}$ is the threshold voltage (zero-bias) of n-type MOS (NMOS) transistors. At the input voltages close to threshold voltage there is no simple analytical equation for the transistors to derive the transfer characteristics. Such analysis, however, is not necessary, since (1) and (2) are enough to explain the principle of operation of the proposed circuit. Transfer characteristics (first loop) described by (1) and (2) are shown in Fig. 5 (curve $V_1$). At small input voltages the characteristics do not depend on process corner (or, equivalently, threshold voltage), while at large values there is negative dependence. Note that in modern submicron and deep submicron CMOS technologies, the threshold voltage has much higher variation than the other parameters, such as oxide thickness, mobility, channel length modulation parameter, etc. [12]. For this reason, under PV we understand threshold voltage variation. Also, since the proposed circuit uses long-channel transistors, short-channel effects [11] are not taken into account.

In the second loop, transistors $M_5$ and $M_6$ work in the same regions as transistors $M_1$ and $M_2$. At small values of $V_{out}$ both transistors $M_3$ and $M_4$ operate in subthreshold region, while at large values (greater than the threshold voltage) $M_3$ operates in strong inversion region. $M_4$ remains in subthreshold region, since its gate voltage ($V_3$) is smaller than the threshold voltage, which can be proved by applying (2) to those two transistors. This is true as long as $V_{out}$ is much greater than threshold voltage ($V_{out} \gg 2V_{th}$). Since the operating range of the circuit $V_3$ is smaller than $2V_{th}$ (but larger $V_{th}$), we will assume the subthreshold region for $M_4$ and strong inversion region for $M_3$; using the same equations for both transistors, we will obtain for voltage $V_3$:

$$V_3 = V_{out} - V_{th} \left( 1 + \frac{\sqrt{2c-1}}{c+1} \right)$$  \hspace{1cm} (3)

where $d=\sqrt{(2\beta_m/\beta_n)}$, $c=1+\sqrt{(b-1)/(b+1)}$, $b=\beta_m/\beta_n$. Transfer function described by (3) is shown in Fig. 5 (curve $V_2$).

Fig. 5 shows that there are three crossing points of curves $V_1$ and $V_2$ - one zero and two nonzero points. One of those two points is unstable, so the system cannot remain in that state indefinitely. Thus, there are two stable (working) operating points. Depending on corner (threshold voltage value) the circuit changes its state from non-zero to zero operating point (or vice versa) generating a digital signal ($V_{out}$).

To prove that the proposed circuit can detect the process corner, we show that curves $V_1$ and $V_2$ have a nonzero crossing point at certain values of threshold voltage, but have zero crossing point at other values, i.e. we show that “shift” of the curves causes crossing point “shift”. For that purpose, the derivatives of both voltages with respect to threshold voltage are calculated. Note that $V_{out}$ is assumed constant and the derivatives are calculated for a range near the stable operating point. Also, variation of the oxide thickness and the rest of parameters are assumed constant, since they are too small. Using (2) and (3) derivatives of $V_1$ and $V_2$ are calculated:

$$\frac{\partial V_1}{\partial V_{th}} = - \left( 1 + \frac{\sqrt{2c-1}}{c+1} \right) < 0$$  \hspace{1cm} (4)

$$\frac{\partial V_2}{\partial V_{th}} = \frac{V_{out}-V_{th}}{V_{pp}} \frac{c+1}{2m} > 0$$  \hspace{1cm} (5)

Equations (4) and (5) show that both derivatives have different signs, which means that curves $V_1$ and $V_2$ (Fig. 5) move in opposite directions, which in its turn means there is change in operating point (hence $V_{out}$) location. Thus, threshold voltage change leads to $V_{out}$ change. Properly designing the circuit swing of $V_{out}$ can be made high enough to be used as a digital signal in digital and analog circuits.

Since the voltages $V_1$ and $V_2$ are smaller (close to 0.2V) than the threshold voltage, the operational amplifier (OA) uses PMOS transistors in the input differential stage. The structure of the OA is shown in Fig. 6. It is a simple two-stage amplifier which main purpose is to provide high gain. Since there are no strict requirements on the OA, many other structures, providing high gain can be used [10]. Due to its high gain the OA equalizes the voltages $V_1$ and $V_2$ generating a stable operating point.

Note, that since the circuit has zero operating point, which is stable, it may remain in that state indefinitely after "power-up", which will cause circuit malfunctioning. To avoid that, the
voltage $V_{out}$ should be forced to large value (above stable operating point). Corresponding circuit (forcer) is not shown, since it is not critical block and can be implemented in various ways. After forcing and then releasing (the forcer is off), the system will fall into one of the stable operating points depending on process corner.

While the proposed PCMC deals with process corners, the temperature is assumed constant during its operation. This condition is easily implemented, since the proposed circuit operates when the IC is in testing mode. During testing, the temperature is set to a certain value and kept constant. For this reason, all the equations and statements are derived based on the assumption of constant temperature.

The circuit in Fig. 5 uses only NMOS transistors; consequently, its operating points and output voltage are determined by their parameters, i.e. threshold voltage of NMOS transistor; that is, threshold voltage variation of NMOS transistor is detected via the proposed circuit. In a case if variation of more parameters needs to be detected, the circuit should be modified. In a case of threshold voltage of PMOS transistor, those should be used in the circuit. If channel length variation needs to be detected, short-channel transistors should be used as well. In addition, depending on the application the circuit will be used in, detection of more than one parameter may be needed (e.g. threshold voltage of PMOS and NMOS transistors, channel length simultaneously).

IV. RESULTS

The proposed PCMC has been designed using standard 28 nm CMOS technology. Functional verifications are done via simulator Finesim (Synopsys Inc.). The layout implementation is done using Custom Designer (Synopsys Inc.). For complete verification of the circuit’s performance both regular/skewed and Monte-Carlo corners have been used during simulation. The circuit’s functionality has also been verified for different values of threshold voltage of NMOS transistor. The temperature is set to 25 °C (constant).

![Fig. 7 Transfer characteristics of the first and the second loops (Fig. 4) corresponding to different process corners](image)

Fig. 7 Transfer characteristics of the first and the second loops (Fig. 4) corresponding to different process corners

Since the behavior of the proposed circuit is determined by the transfer characteristics of both loops (first and second loops in Fig. 4), they have been obtained separately for different process corners (Fig. 7) and threshold voltage values (Fig. 8). Plots show that in both cases that the transfer characteristics have stable zero and non-zero operating points. Also, process corner or threshold voltage change leads to crossing/operating point change (i.e. their “detection” is possible). Note the similarity between the curves of Figs. 4 and 6, which means that (1)-(3) describe the characteristics quiet well.

To directly check detection/monitoring capability, the output signal (versus threshold voltage shift) has been plotted (Fig. 9). The figure shows that starting from some values of threshold voltage shift the $V_{out}$ drops to 0. Corresponding “transition” value, referred to as the switching point, is marked by dot A. There is one key point here to discuss. It is related to $V_{out}$ drop. The key point is that the $V_{out}$ derivative (with respect to threshold voltage) is indefinite at the switching point. Only in this case can it be used as the digital signal for other blocks.

![Fig. 8 Transfer characteristics of the first and the second (Fig. 4) loops corresponding to different values of the threshold voltage shift](image)

Fig. 8 Transfer characteristics of the first and the second (Fig. 4) loops corresponding to different values of the threshold voltage shift

Since the purpose of the proposed PCMC is to monitor the process corner, i.e. die-to-die variations [3], [4], its function has been checked across different corners. In reality, however, there are also within-die variations [3], which impact the circuits’ behavior. To verify the robustness of the proposed circuit in the presence of within-die variations, Monte-Carlo simulations have been run (1000 corners), which includes both process corner (slow, typical and fast) and local mismatch of all transistors. The results are given in Fig. 10.
Results show that even in a presence of within-die variations the circuit can monitor process corners. Note that the output voltage is high (logic “1”) in both typical and slow corners, i.e. the circuit does not detect those corners. On the other hand, it is 0 in fast corner. Thus, high voltage at the output will denote slow or typical, and low voltage at the output will denote fast corner. The key feature of the proposed circuit is its ability to detect at least one corner; and in the case of more corners, it should be modified slightly. If it is necessary to have higher accuracy, e.g. divide the range between fast and slow corners on more “sub ranges”, more output signals will be needed. Particularly, to exactly detect the mentioned three corners, it is possible to add another loop similar to the first loop (Fig. 4) with different transfer characteristics. With that loop being active, the output voltage will be low in fast and typical corners, while high in only slow corner. Thus, we will be able to exactly determine the process corner by measuring the output voltage by activating those loops sequentially.

To ensure that the OA is stable as well, the AC characteristic for slow, typical and fast corners are obtained (Fig. 11). The plots show, that the worst DC gain of the OA is ~69 db, the phase margin ~68 deg. Thus, the OA has sufficient gain and stability margin.

To confirm that the proposed circuit is fully functional and can detect process corner even in the presence of within-die variations.

V. CONCLUSION

A PCMC has been presented in the current work. The circuit monitors process corner by generating a digital signal (voltage), which can be used in digital and analog circuits. The key feature of the circuit is that it utilizes only MOS transistors, which allows achieving small area, current consumption and high detection accuracy. The circuit is easily implemented in CMOS technology, and can be further modified if monitoring of more parameters or corners is needed. Post extraction simulation results confirm that the circuit can detect process corner in the presence of within-die variations. Simplicity of its structure does not require additional functional pins or any additional testing operations when used on a chip. This leads to a reduction of testing time and cost of ICs.

REFERENCES


